

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("5347426").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 09:57
L2	23	(("4916113") or ("5420085") or ("3918141") or ("5108964") or ("5298339") or ("4851375") or ("4935055") or ("5395701") or ("5162273") or ("4828008") or ("5482778") or ("5385914") or ("5856025")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 10:01
L3	0	(copper adj matrix adj compsite)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 10:02
L4	39	(copper adj matrix adj composite)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 10:28
L5	5	(copper adj impregnated adj SiC)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 10:37
L6	2069559	(AlN or Aluminium nitride or silicon nitride)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 10:38
L8	348	(IHS or heat adj spreader) and l6 and (ceramic adj substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 10:43
L9	197	l8 and @pd< "20030221"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 10:50

L10	187	(hard adj solder) and (melting adj temperature) and high	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 10:49
L11	147	l10 and @pd< "20030221"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:07
L12	0	(higher with 600C) and l11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:01
L13	103	(high adj melting adj temperature adj solder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:07
L14	75	l13 and @pd< "20030221"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:21
L15	2	("4797328").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 11:17
L16	0	("((integratedadjheatadjspreader)or IHS)with(copperadjalloy)").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 11:18
L17	19	((integrated adj heat adj spreader) or IHS) with (copper adj alloy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:20

L18	461	((integrated adj heat adj spreader) or IHS) and (copper adj alloy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:21
L20	423	l18 and @pd< "20030221"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:27
L21	150	((integrated adj heat adj spreader) or IHS) same (copper adj alloy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:21
L22	137	l21 and @pd< "20030221"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:22
L25	5448	(copper adj alloy) and (copper adj (chromium or zirconium or silver or zinc or iron or phosphorous or alumina))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:28
L26	55	(heat adj spreader) and L25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 11:28
L27	25	L26 and @pd< "20030221"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 12:35
L28	2825	(LGA or PGA or BGA) and (lid or IHS or (integrated adj heat adj spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 12:37

L29	2146	I28 and @pd< "20030212"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 12:37
L30	3603	(die and lid and substrate) and thickness	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 12:38
L31	176	I29 and I30	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 13:08
L32	83367	(alloy\$3 and copper and strength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 13:09
L33	29567	I32 and improved and mechanical and strength	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 13:09
L35	185	(copper adj chromium adj alloy) and strength	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 13:10
L36	142	I35 and @pd< "20030101"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 13:10
L37	0	("s14and(heatadjspreader)").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 15:05

L38	5998	(361/704-722).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 15:05
L39	529	L38 and (heat adj spreader)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 15:06
L40	184	I39 and (chromium alloy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 15:06
L41	114	I39 and ((chromium alloy) with copper)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 15:07
L42	60	I39 and ((chromium alloy) with ((heat adj spreader) or IHS))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/08 15:43
L43	2	("6110577").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 15:43
S1	236	(361/708).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/07 12:51
S2	541	((yield adj stress) or (proof adj stress)) and (thermal adj conductivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 12:48

S3	49	la and S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 12:48
S4	0	S1 and S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 12:48
S5	0	("2004/0207987").URPN.	USPAT	OR	ON	2005/11/07 12:48
S6	106	(ceramic and S1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 12:51
S7	30	(ceramic adj substrate) and S1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 13:52
S8	30943	(copper adj alloy) and (copper and (chromium or zirconium or silver or zinc or iron or phosphorous or alumina))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 13:55
S9	5446	(copper adj alloy) and (copper adj (chromium or zirconium or silver or zinc or iron or phosphorous or alumina))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:33
S10	55	(heat adj spreader) and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:19
S11	377860	(heat adj treat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 13:56

S12	1127	S11 and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 13:56
S13	9	S11 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 13:58
S14	5995	(361/704-722).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/08 15:04
S15	310	(S14 and (copper adj alloy))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 13:59
S16	246	S15 and ((heat adj (sink or spreader)) or IHS)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 13:59
S17	0	(heat adj spreader) with (copper adj array)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:20
S18	108	(heat adj spreader) with (copper adj alloy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:20
S19	945	(copper adj alloy) and (copper adj (chromium or zirconium or silver or zinc or iron or phosphorous or alumina)) and (heat adj treatment)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:46

S20	256	(copper adj alloy) and (copper adj (chromium or zirconium or silver or zinc or iron or phosphorous or alumina)) adj alloy and (heat adj treatment)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:50
S21	13147	(copper adj chromium) or (copper adj zirconium) or (copper adj silver) and (heat adj treatment)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:52
S22	3315	((copper adj chromium) or (copper adj zirconium) or (copper adj silver)) and (heat adj treatment)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 14:53
S23	130	S22 and (thermal adj conductivity) and ((mechanical adj properties) or (tensile adj properties) or (yield adj strength) or (proof adj strength))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 15:01
S24	44	(alumina adj dispersed adj copper)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 16:10
S25	834188	(copper adj chromium) alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 16:14
S26	412	(copper adj chromium) adj alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 16:14
S27	72	((copper adj chromium) adj alloy) and (heat adj treat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/07 16:15